

Title (en)

A self-heating or self-cooling pack

Title (de)

Selbsterwärmendes oder selbstkühlendes Pack

Title (fr)

Pack de chauffage ou refroidissement automatique

Publication

**EP 2896908 A1 20150722 (EN)**

Application

**EP 14151695 A 20140118**

Priority

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Abstract (en)

The present invention refers to an adaptable device comprising a plurality of elements, each element comprising a first containing means which is delimited by a first surface, and contains a first one or more reagent, in contact with or connected to a second containing means which is delimited by a second surface, and contains a second one or more reagent, wherein said first surface, said second surface or both, comprise rupturable means configured to, while maintaining the integrity of the rest of at least one of said surfaces, break upon pressure so as to produce a temperature changing reaction through contact between said first one or more reagent and said second one or more reagent, characterized in that said device comprises two or more elements and each element is separated by non-rupturable separating means configured to maintain integrity upon said pressure.

IPC 8 full level

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CPC (source: EP)

**F24V 30/00** (2018.04)

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